STP36N60M6, STW36N60M6

N-channel 600 V, 85 mΩ typ., 30 A MDmesh[™] M6 Power MOSFETs in TO-220 and TO-247 packages

 TAB

 Image: Constrained state

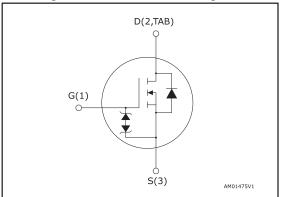
 Image: Constrained state

 TO-220

 TO-247

life.augmented

Figure 1: Internal schematic diagram



Features

Order code	V _{DS} R _{DS(on)} max.		ID
STP36N60M6	600 V	00 mQ	20.4
STW36N60M6	600 V	99 mΩ	30 A

Datasheet - production data

- Reduced switching losses
- Lower R_{DS(on)} x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

The new MDmesh[™] M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent R_{DS(on)} * area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum endapplication efficiency.

Table	1:	Device	summary
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Order code	Marking	Package	Packaging
STP36N60M6	261160146	TO-220	Tuba
STW36N60M6	36N60M6	TO-247	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{GS}	Gate-source voltage	±25	V	
ID	Drain current (continuous) at T _C = 25 °C	30	А	
ID	Drain current (continuous) at T _C = 100 °C	19	А	
ID ⁽¹⁾	Drain current (pulsed)	102	А	
Ртот	Total dissipation at T_c = 25 °C	208	W	
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns	
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns	
T _{stg}	Storage temperature range			
Tj	Operating junction temperature range	-55 to 150 °		

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{(2)}I_{SD} \le 30$ A, di/dt ≤ 400 A/µs, V_DS(peak) < V(BR)DSS, V_DD = 400 V. $^{(3)}V_{DS} \le 480$ V

Table 3: Thermal data

Symbol Parameter		Val	Unit		
Symbol	Falanetei	TO-220	TO-247	Unit	
R _{thj-case}	Thermal resistance junction-case	0.6		°C/W	
R _{thj-amb}	Thermal resistance junction-ambient	62.5	50	°C/W	

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	5	А
Eas	Single pulse avalanche energy (starting $T_j = 25 \text{ °C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	750	mJ



2 **Electrical characteristics**

 T_C = 25 °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	600			V
I _{DSS} Zero gate voltage drain current	V_{GS} = 0 V, V_{DS} = 600 V			1	μA	
	V_{GS} = 0 V, V_{DS} = 600 V, T _c = 125 °C ⁽¹⁾			100	μA	
lgss	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±25 V			±5	μA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	3.25	4	4.75	V
R _{DS(on)}	Static drain-source on-resistance	V_{GS} = 10 V, I _D = 15 A		85	99	mΩ

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1960	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V		93	-	pF
Crss	Reverse transfer capacitance			6	-	pF
Coss eq. ⁽¹⁾	Equivalent output capacitance	$V_{\rm DS}$ = 0 to 480 V, $V_{\rm GS}$ = 0 V	-	332	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	1.6	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 30 A,	-	44.3	-	nC
Qgs	Gate-source charge	V _{GS} = 0 to 10 V (see Figure 17: "Test circuit for	-	10.1	-	nC
Q_{gd}	Gate-drain charge	gate charge behavior")	-	25	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}C_{\text{oss eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% VDSS



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Electrical characteristics

	Table 7: Switching times						
Symbol	Parameter	Min.	Тур.	Max.	Unit		
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 15 A,	-	15.2	-	ns	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 18: "Test circuit for	-	5.3	-	ns	
t _{d(off)}	Turn-off-delay time	inductive load switching and	-	50.2	-	ns	
tr	Fall time	inductive load switching and diode recovery times" and Figure 21: "Switching time waveform")	-	7.3	-	ns	

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		30	А
Isdm, ⁽¹⁾	Source-drain current (pulsed)		-		102	А
Vsd ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 30 A	-		1.6	V
trr	Reverse recovery time	I _{SD} = 30 A, di/dt = 100 A/µs,	-	340		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 V$ (see Figure 18: "Test circuit for	-	5.3		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	31		А
trr	Reverse recovery time	I _{SD} = 30 A, di/dt = 100 A/µs,	-	430		ns
Qrr	Reverse recovery charge	V_{DD} = 60 V, T _j = 150 °C (see Figure 18: "Test circuit for	-	7.7		μC
IRRM	Reverse recovery current	inductive load switching and diode recovery times")	-	36		A

Table 8: Source drain diode

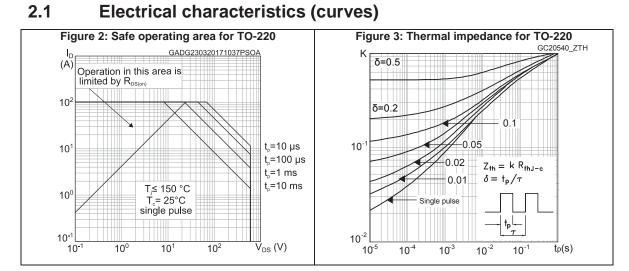
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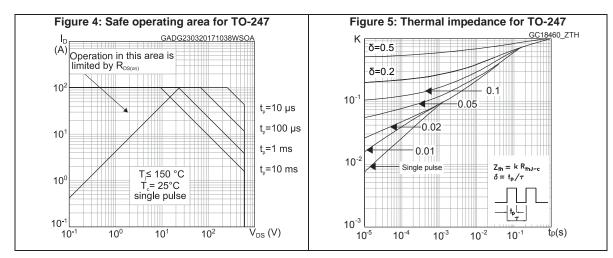
⁽¹⁾Pulse width is limited by safe operating area.

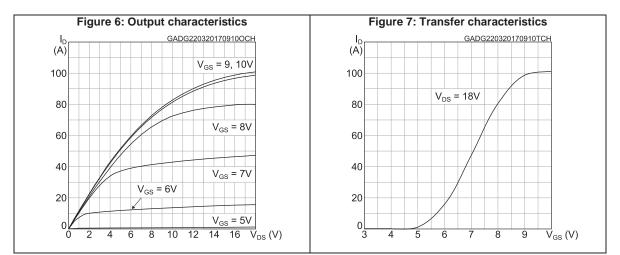
 $^{(2)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%



Electrical characteristics





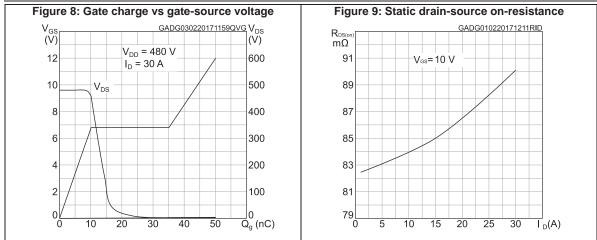


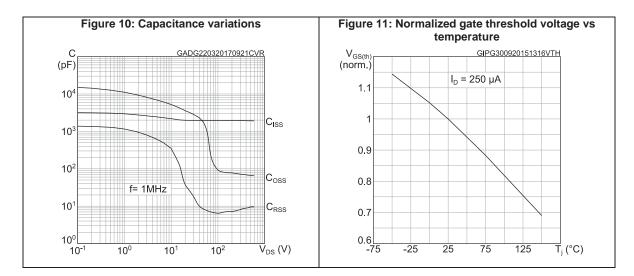
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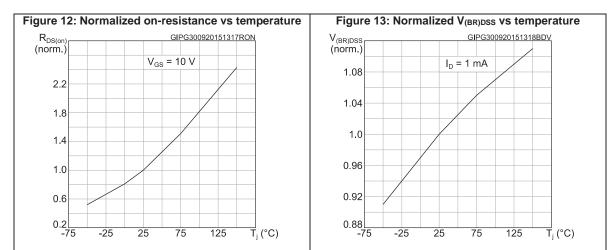


STP36N60M6, STW36N60M6

Electrical characteristics







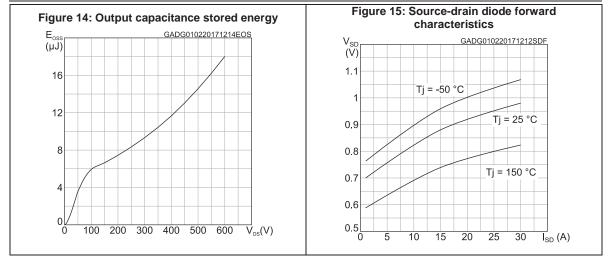
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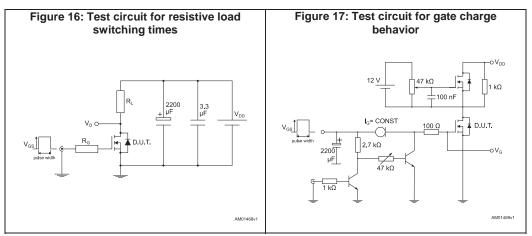
Electrical characteristics

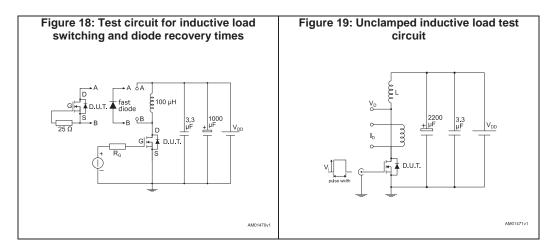
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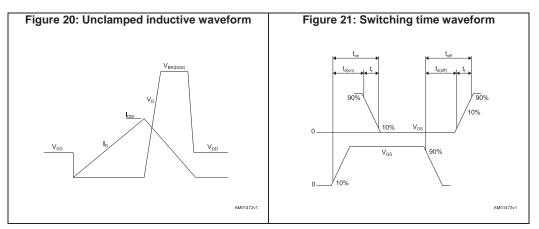




3 Test circuits







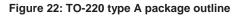


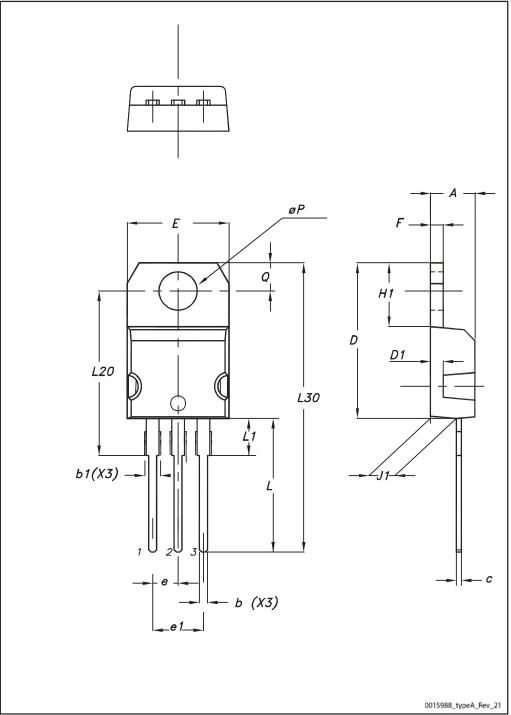
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



4.1 TO-220 type A package information







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Package information

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	Table 9: TO-220 typ	e A mechanical data	
Dim		mm	
Dim.	Min. Typ.		Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95



4.2 **TO-247** package information

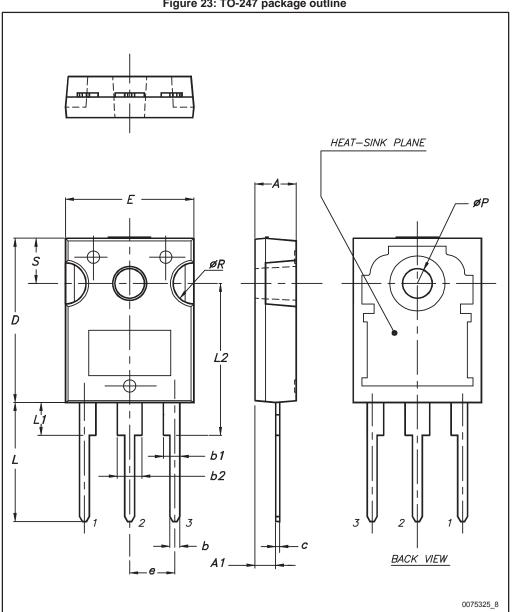


Figure 23: TO-247 package outline



Package information

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Table 10: TO-247 package mechanical data				
Dim.	mm			
	Min.	Тур.	Max.	
A	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
e	5.30	5.45	5.60	
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S	5.30	5.50	5.70	

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5 Revision history

Table 11: Document revision	history
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Date	Revision	Changes
06-Oct-2015	1	First release
14-Oct-2015	2	Updated: V _{DD} value in <i>Table 8: "Source drain diode"</i> Minor text changes
27-Mar-2017	3 Updated <i>Table 2: "Absolute maximum ratings".</i> Updated <i>Section 2: "Electrical characteristics".</i> Updated <i>Section 4: "Package information".</i> Minor text changes	



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